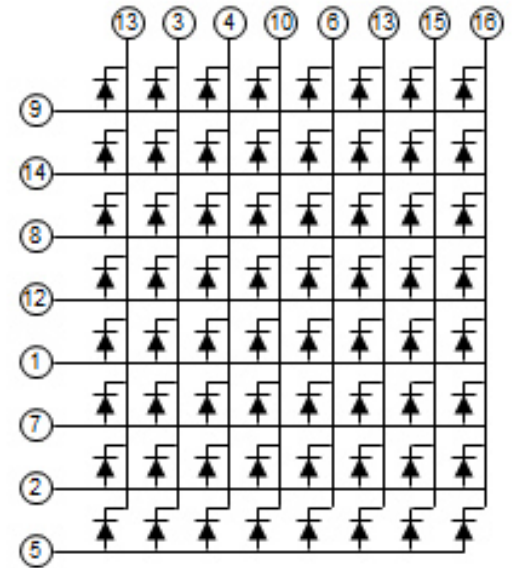
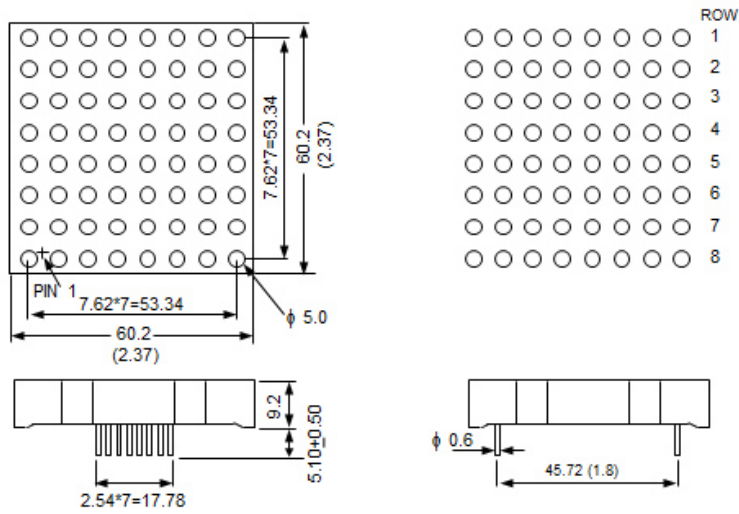


PCB PIN CONNECTON

DEVICE DIAGRAM



Absolute Maximum Rating ($T_a = 25^{\circ}\text{C}$)

PARAMETER	MAXIMUM RATING	UNITS
Power Dissipation per Dot	40	mW
DC Forward Current per Dot	20	mA
Reverse Voltage per Dot ($I_R = 10\text{mA}$)	5	V
Peak Pulse Forward Current per Dot (1)	100	mA
Operating Temperature	-40 to +80	$^{\circ}\text{C}$
Storage Temperature	-40 to +100	$^{\circ}\text{C}$

- (1) Pulse conditions of 1/10 duty and 0.1msec width, for long operating life, max. of 20mA recommended
 (2) Solder Temperature of 1/16" Below Seating Plane for 5 Seconds at 260°C

Electro-optical Characteristics ($T_a = 25^{\circ}\text{C}$)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Forward Voltage per Dot	V_F	$I_F = 20\text{mA}$		3.3	3.8	V
Reverse Current per Dot	I_R	$V_R = 5\text{V}$			40	mA
Chromaticity Coordinate	x	$I_F = 20\text{mA}$		0.31		
	y	$I_F = 20\text{mA}$		0.32		
Luminous Intensity	I_V	$I_F = 20\text{mA}$		35		mcd
Luminous Intensity Matching Ratio	$I_V\text{-m}$	$I_F = 20\text{mA}$		2:1		